Specification of Thermoelectric Module

TEC1-06308

Description

The 63 couples, 20 mm × 40 mm size single module which is made of selected high performance ingot to achieve superior cooling performance and greater delta T up to 70 °C, designed for superior cooling and heating up to 100 °C applications. If higher operation or processing temperature is required, please specify, we can design and manufacture the custom made module according to your special requirements.

Features

- No moving parts, no noise, and solid-state
- Compact structure, small in size, light in weight
- Environmental friendly
- RoHS compliant
- Precise temperature control
- Exceptionally reliable in quality, high performance

Application

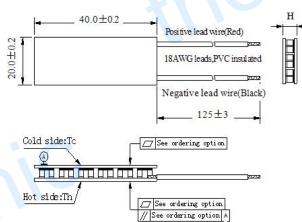
- Food and beverage service refrigerator
- Portable cooler box for cars
- Liquid cooling
- Temperature stabilizer
- CPU cooler and scientific instrument
- Photonic and medical systems

Performance Specification Sheet

Th(°C)	27	50	Hot side temperature at environment: dry air, N ₂	
DT _{max} (°C)	70	79	Temperature Difference between cold and hot side of the module when cooling capacity is zero at cold side	
U _{max} (Voltage)	7.8	8.5	Voltage applied to the module at DT _{max}	
I _{max(} amps)	8.5	8.5	DC current through the modules at DT _{max}	
Q _{Cmax} (Watts)	42.8	46.1	Cooling capacity at cold side of the module under DT=0 °C	
AC resistance(ohms)	0.70	0.75	The module resistance is tested under AC	
Tolerance (%)	± 10		For thermal and electricity parameters	

Geometric Characteristics Dimensions in millimeters

Manufacturing Options



- 1. T100: BiSn (Tmelt=138°C)
- 2. T200: CuSn (Tmelt = 227 °C)
- B. Sealant:

A. Solder:

- 1. NS: No sealing (Standard)
- 2. SS: Silicone sealant
- 3. EPS: Epoxy sealant
- 4. Customer specify sealing

other than above

C. Ceramics:

- 1. Alumina (Al₂O₃, white 96%)
- 2. Aluminum Nitride (AlN)

D. Ceramics Surface Options:

- 1. Blank ceramics (not metallized)
- 2. Metallized (Au plating)

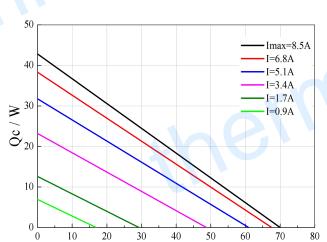
Ordering Option

Suffix	Thickness	Flatness/ Parallelism (mm)	Lead wire length(mm)			
	H (mm)		Standard/Optional length			
TF	$0:3.4 \pm 0.1$	0: 0.1/0.1	125±3/Specify			
TF	$1:3.4 \pm 0.08$	1: 0.08/0.08	125±3/Specify			
TF	$2:3.4 \pm 0.05$	2: 0.05/0.05	125±3/Specify			
Eq. TE01: Thickness 2.4 ± 0.1 (mm) and Elatracs $0.08/0.08$ (mm)						

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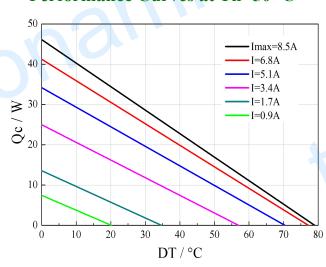
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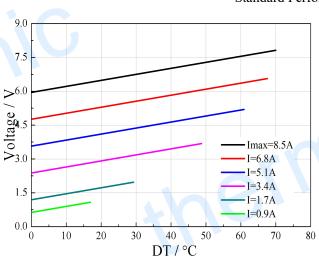


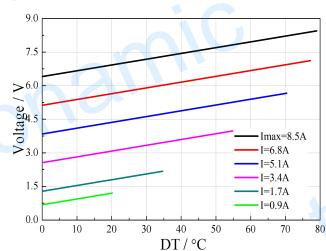
DT / °C

Performance Curves at Th=50 °C

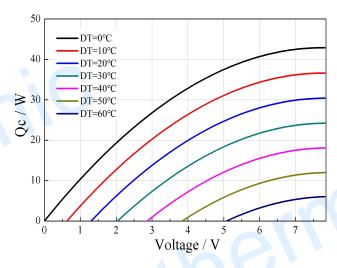


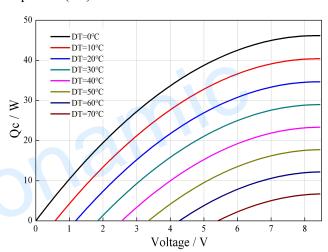
Standard Performance Graph Qc= f(DT)





Standard Performance Graph $V = f(\Delta T)$





Standard Performance Graph Qc = f(V)

Specification of Thermoelectric Module

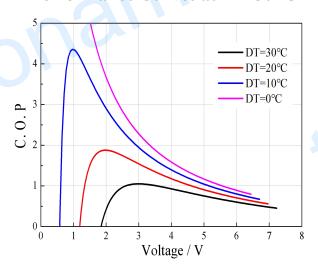
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Performance Curves at Th=27 °C

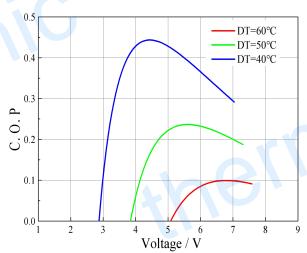
5 4 — DT=30°C — DT=20°C — DT=10°C — DT=0°C — DT=0°C

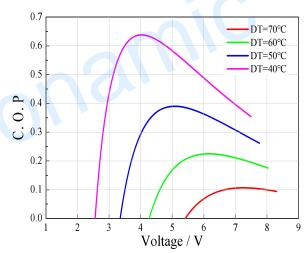
Voltage / V

Performance Curves at Th=50 °C



Standard Performance Graph COP = f(V) of ΔT ranged from 0 to 30 °C





Standard Performance Graph COP = f(V) of ΔT ranged from 40 to 60/70 °C

Remark: The coefficient of performance (COP) is the cooling power Qc/Input power (V × I).

Operation Cautions

- Attach the cold side of module to the object to be cooled
- Attach the hot side of module to a heat radiator for heat dissipating
- Operation below I_{max} or V_{max}
- Work under DC

Note: All specifications subject to change without notice.